SiA446DJ

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Vishay Siliconix

N-Channel 150 V (D-S) MOSFET

FEATURES

ThunderFET[®] technology optimizes balance

For definitions of compliance please see

of R_{DS(on)}, Q_g, Q_{sw} and Q_{oss} • 100 % R_q and UIS tested

www.vishay.com/doc?99912

DC/DC converters / boost converters

5.3

6.5

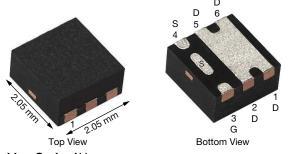
Material categorization:

Synchronous rectification
Power management
LED backlighting

APPLICATIONS

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A) ^a	Q _g (TYP.)			
150	0.177 at V _{GS} = 10 V	7.7				
	0.185 at V _{GS} = 7.5 V	7.6	4.3 nC			
	0.250 at V _{GS} = 6 V	4				

PowerPAK[®] SC-70-6L Single



Marking Code: AV

Ordering Information:

SiA446DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted) SYMBOL PARAMETER LIMIT UNIT **Drain-Source Voltage** 150 V_{DS} V V_{GS} ± 20 Gate-Source Voltage $T_C = 25 \circ C$ 7.7 T_C = 70 °C 6.2 Continuous Drain Current (T_J = 150 °C) I_D T_A = 25 °C 3.3^{b, c} 2.6^{b, c} T_A = 70 °C А Pulsed Drain Current (t = 100 µs) 10 I_{DM} $T_C = 25 \ ^{\circ}C$ 12 Continuous Source-Drain Diode Current Is 2.9^{b, c} T_A = 25 °C Single Pulse Avalanche Current 7 I_{AS} L = 0.1 mHSingle Pulse Avalanche Energy 2.5 E_{AS} mJ T_C = 25 °C 19 T_C = 70 °C 12 Maximum Power Dissipation W P_D $T_A = 25 \circ C$ 3.5^{b, c} T_A = 70 °C 2.2 ^{b, c} Operating Junction and Storage Temperature Range -55 to 150 T_J, T_{sta} °C

Soldering Recommendations (Peak Temperature) ^d		2	Ũ		
THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient b, f	t ≤ 5 s	R _{thJA}	28	36	°C/W
Mautineum lumetice to Ocean (Ducto)	Oto a shu Otota	D	г 0	0.5	C/W

Steady State

- Notes
- a. Based on $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.

Maximum Junction-to-Case (Drain)

c. t = 5 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

R_{thJC}

- e. Rework conditions: Manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.

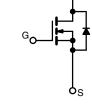
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ROHS COMPLIANT HALOGEN



N-Channel MOSFET

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	н.						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V$, $I_D = 250 \mu A$	150	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	73	-	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6	-		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.5	-	3.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
	I _{DSS} -	V _{DS} = 150 V, V _{GS} = 0 V	-	-	1	μA	
Zero Gate Voltage Drain Current		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10	-	-	А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	-	0.145	0.177	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, I_D = 2 \text{ A}$	-	0.151	0.185		
		$V_{GS} = 6 V, I_D = 1 A$	-	0.165	0.250		
Forward Transconductance a	g _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	-	6	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	230	-	pF	
Output Capacitance	C _{oss}	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz	-	47	-		
Reverse Transfer Capacitance	C _{rss}		-	8	-		
· · · · · · · · · · · · · · · · · · ·		V _{DS} = 75 V, V _{GS} = 10 V, I _D = 3.5 A	-	5.3	8		
Total Gate Charge	Qg		-	4.3	6.5	-	
Gate-Source Charge	Q _{gs}	V_{DS} = 75 V, V_{GS} = 7.5 V, I_{D} = 3.5 A	-	1.2	-	nC	
Gate-Drain Charge	Q _{gd}		-	1.8	-		
Output Charge	Q _{oss}	$V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	8.5	-		
Gate Resistance	Rg	f = 1 MHz	0.5	2.3	4.6	Ω	
Turn-On Delay Time	t _{d(on)}		-	5	10		
Rise Time	t _r	$V_{DD} = 75 V, R_1 = 29 \Omega,$	-	13	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 2.6 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	10	20		
Fall Time	t _f		-	10	20		
Turn-On Delay Time	t _{d(on)}		-	10	20	ns	
Rise Time	tr	$V_{DD} = 75 V, R_1 = 29 \Omega,$	-	40	80		
urn-Off Delay Time t _{d(off)}		$I_D \cong 2.6 \text{ A}, V_{\text{GEN}} = 6 \text{ V}, R_g = 1 \Omega$	-	5	10	1	
Fall Time	t _f		-	10	20		
Drain-Source Body Diode Characteristic	S				1	•	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	12	A	
Pulse Diode Forward Current (t = 100 µs)	I _{SM}	-	-	-	10		
Body Diode Voltage	V _{SD}	I _S = 3.5 A	-	0.9	1.2	V	
Body Diode Reverse Recovery Time			-	51	100	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 3.5 A, dl/dt = 100 A/μs,	-	100	200	nC	
Reverse Recovery Fall Time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	43	-	- ns	
Reverse Recovery Rise Time	t _b		_	8	_		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

0.4 2 4 5 0 1 3 6 100 - 50 - 25 0 25 50 75 Q_g - Total Gate Charge (nC) T_J - Junction Temperature (°C) Gate Charge **On-Resistance vs. Junction Temperature**

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125

150

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- 55 °C $T_{C} =$

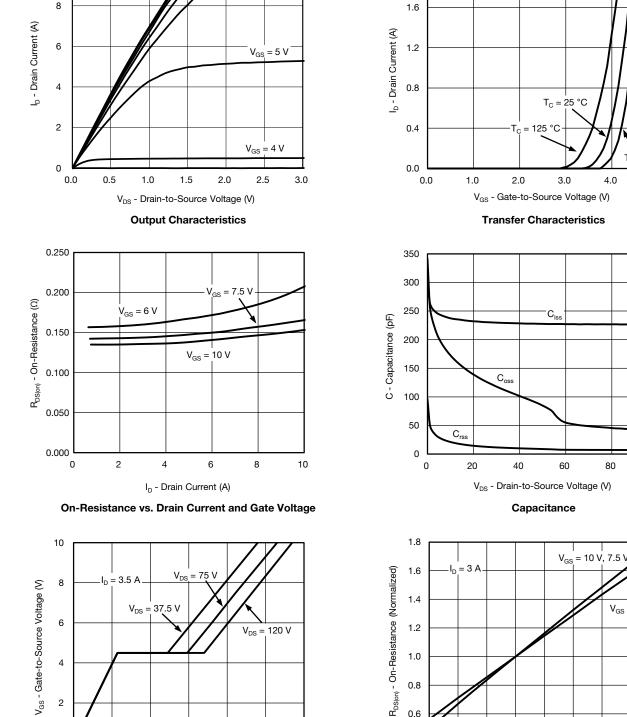
5.0

4.0

80

 $V_{GS} = 6 V$

100



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

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= 10 V thru 6 V

V_{GS}

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0.6

2.0

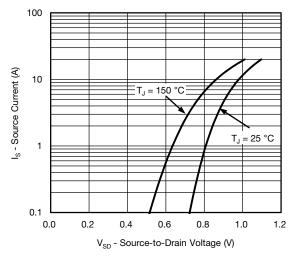
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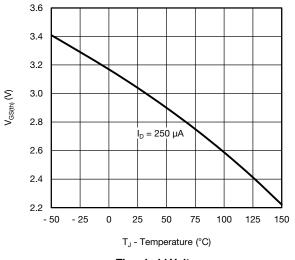
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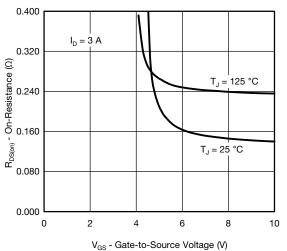
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



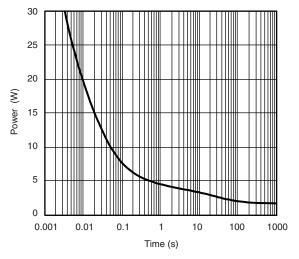
Source-Drain Diode Forward Voltage



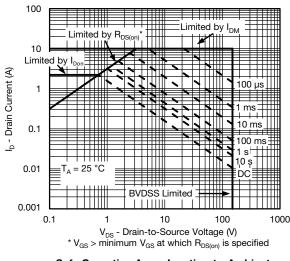
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient 4

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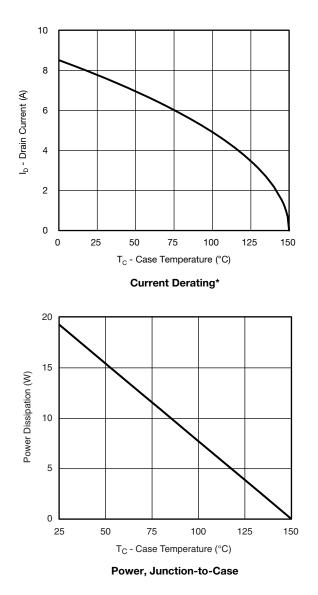
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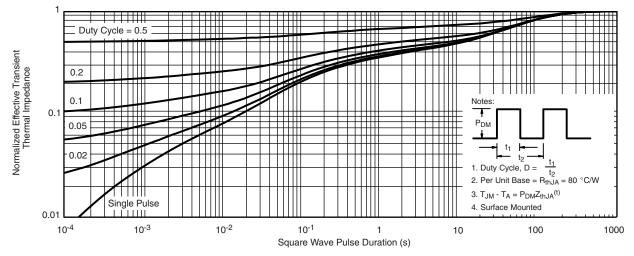


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

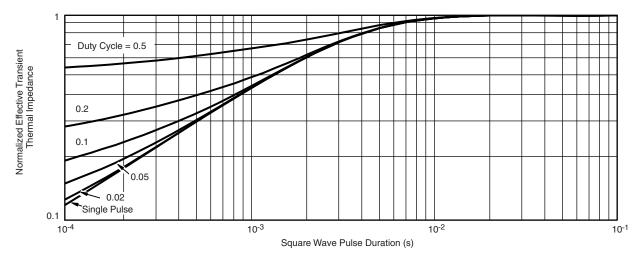


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62925.



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

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RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

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